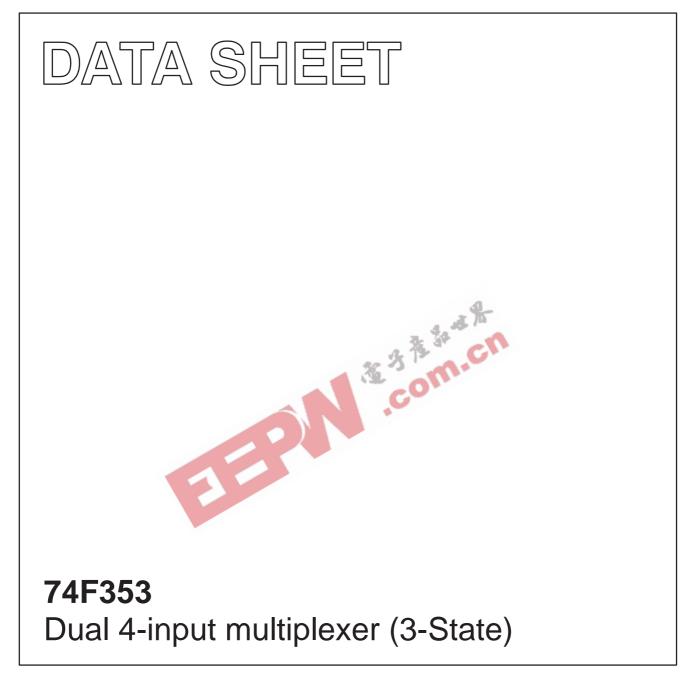
INTEGRATED CIRCUITS



Product specification IC15 Data Handbook 1996 Jan 05



74F353

FEATURES

- Inverting version of 74F253
- 3-State outputs for bus interface and multiplex expansion
- Common select inputs
- Separate Output Enable Inputs

DESCRIPTION

The 74F353 has two identical 4-input multiplexers with 3-State outputs which select two bits from four sources selected by common Select inputs (S0, S1). When the individual Output Enable (\overline{OEa} , \overline{OEb}) inputs of the 4-input multiplexers are High, the outputs are forced to a high impedance (Hi-Z) state.

The 74F353 is the logic implementation of a 2-pole, 4-position switch; the position of the switch being determined by the logic levels supplied to the two common Select inputs.

To avoid exceeding the maximum current ratings when the outputs of the 3-State devices are tied together, all but one device must be in the high-impedance state. Therefore, only one Output Enable must be active at a time.

PIN CONFIGURATION

OEa 1	16 V _{CC}
S1 2	15 OEb
I3a 3	14 S0
l2a 4	13 I3b
l1a 5	12 I2b
10a 6	11 I1b
Ya 7	10 IOb
GND 8	9 Yb
	SF00891

ТҮРЕ	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F353	6.0ns	11mA

ORDERING INFORMATION

DESCRIPTION	$\begin{array}{l} \text{COMMERCIAL RANGE} \\ \text{V}_{\text{CC}} = 5\text{V}\pm10\%, \\ \text{T}_{amb} = 0^{\circ}\text{C to} +70^{\circ}\text{C} \end{array}$	PACKAGE DRAWING NUMBER
16-pin plastic DIP	N74F353N	SOT38-4
16-pin plastic SO	N74F353D	SOT162-1

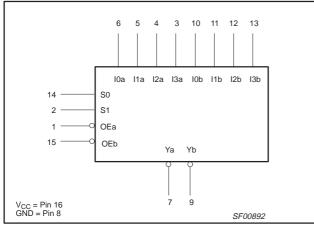
INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
10a–13a	Port A data inputs	1.0/1.0	20µA/0.6mA
I0b–I3b	Port B data inputs	1.0/1.0	20µA/0.6mA
S0, S1	Common Select inputs	1.0/1.0	20µA/0.6mA
ŌĒa	Port A Output Enable input (active Low)	1.0/1.0	20µA/0.6mA
OEb	Port B Output Enable input (active Low)	1.0/1.0	20µA/0.6mA
₹ Ya, Yb	3-State outputs	150/40	3mA/24mA

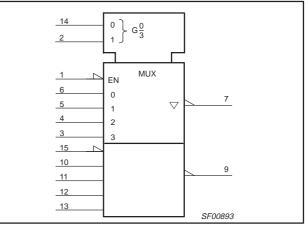
NOTE:

One (1.0) FAST unit load is defined as: 20μ A in the High state and 0.6mA in the Low state.

LOGIC SYMBOL



IEC/IEEE SYMBOL

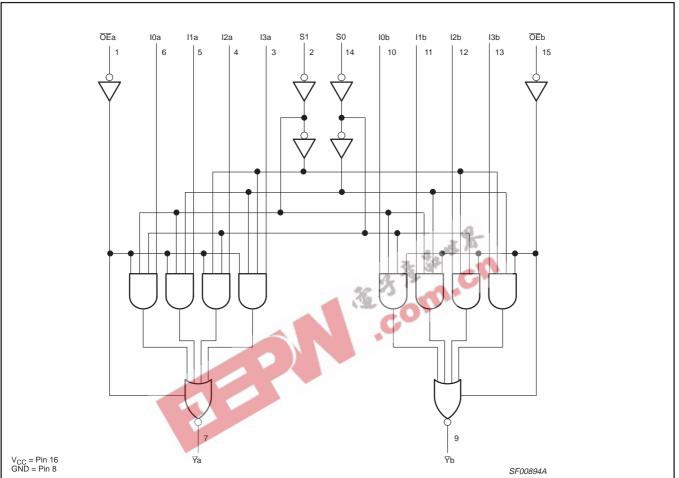


Product specification

Dual 4-input multiplexer (3-State)

74F353

LOGIC DIAGRAM



FUNCTION TABLE

			INPUTS				OUTPUT
S0	S1	10	11	12	13	ŌĒ	Ŷ
Х	Х	Х	Х	Х	Х	Н	Z
L	L	L	х	х	х	L	н
L	L	н	х	х	х	L	L
н	L	х	L	х	х	L	н
н	L	х	н	х	х	L	L
L	н	х	х	L	х	L	н
L	н	х	х	н	х	L	L
н	н	х	х	х	L	L	н
н	н	х	х	х	н	L	L

NOTES:

H = High voltage level L = Low voltage level X = Don't care Z = High impedance "off" state

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ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _{IN}	Input voltage	-0.5 to +7.0	V
I _{IN}	Input current	-30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	–0.5 to V_{CC}	V
I _{OUT}	Current applied to output in Low output state	48	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	0	LIMITS		UNIT
STNIBUL	PARAMEIER	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V
V _{IL}	Low-level input voltage	101		0.8	V
I _{IK}	Input clamp current			-18	mA
I _{OH}	High-level output current	1		-3	mA
I _{OL}	Low-level output current			24	mA
T _{amb}	Operating free-air temperature range	0		70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

CVMDOI	DADAMETER		TEOT	CONDITION	01		LIMITS		UNIT
SYMBOL	PARAMETER		TEST CONDITIONS ¹			MIN	TYP ²	MAX	UNIT
M			$V_{CC} = MIN, V_{IL} =$	MAX,	±10%V _{CC}	2.4			V
V _{OH}	High-level output voltage		$V_{CC} = MIN, V_{IL} = V_{IH} = MIN, I_{OH} = I$	XAN	±5%V _{CC}	2.7	3.3		V
M			$V_{CC} = MIN, V_{IL} =$	MAX,	±10%V _{CC}		0.35	0.50	V
V _{OL}	Low-level output voltage		$V_{IH} = MIN, I_{OL} = N$		±5%V _{CC}		0.35	0.50	V
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{II}$	<	•		-0.73	-1.2	V
l	Input current at maximum input voltage		$V_{CC} = MAX, V_I = 7.0V$					100	μΑ
I _{IH}	High-level input current		$V_{CC} = MAX, V_I = 2.7V$					20	μΑ
IIL	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$					-0.6	mA
I _{OZH}	Off-state output current High-level voltage applied		$V_{CC} = MAX, V_O = 2.7V$					50	μA
I _{OZL}	Off-state output current Low-level voltage applied		$V_{CC} = MAX, V_{O} =$	$V_{CC} = MAX, V_O = 0.5V$				-50	μA
I _{OS}	Short-circuit output current ³		$V_{CC} = MAX$			-60		-150	mA
		I _{ССН}		OEn=Sn=Ir	n=GND		9	14	mA
I _{CC}	Supply current (total)	Supply current (total)		V _{CC} = MAX OEn=Sn=GND, In=4.5V			11	20	mA
		I _{CCZ}		0En=4.5V,	Sn=In=GND		13	23	mA

NOTES:

2. All typical values are at $V_{CC} = 5V$, $T_{amb} = 25^{\circ}C$.

 Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

^{1.} For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

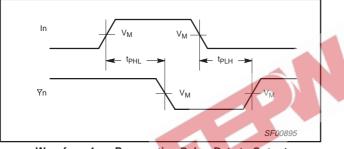
74F353

					LIN	MITS		
SYMBOL	PARAMETER	TEST CONDITION	T ₂ C _L = 5	V _{CC} = 5V amb = +25° 50pF, R _L =	C 500Ω	$T_{amb} = 0^{\circ}C$	V ± 10% C to +70°C R _L = 500Ω	UNIT
			MIN	ТҮР	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay In to $\overline{Y}n$	Waveform 1	3.0 1.5	5.0 3.0	7.0 5.0	3.0 1.0	8.0 5.5	ns
t _{PLH} t _{PHL}	Propagation delay Sn to \overline{Y} n	Waveform 2	5.0 3.0	9.0 6.0	12.0 8.5	4.5 3.0	12.5 9.5	ns
t _{PZH} t _{PZL}	Output Enable time to High or Low level	Waveform 3 Waveform 4	4.0 4.0	6.0 6.5	8.0 8.0	3.5 3.5	9.0 9.0	ns
t _{PHZ} t _{PLZ}	Output Disable time from High or Low level	Waveform 3 Waveform 4	2.5 1.5	4.0 2.5	5.5 6.0	2.0 1.5	6.0 7.0	ns

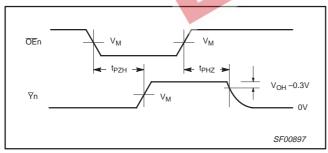
AC ELECTRICAL CHARACTERISTICS

AC WAVEFORMS

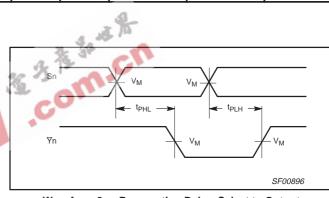
For all waveforms, $V_M = 1.5V$



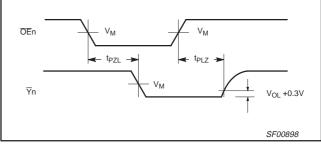
Waveform 1. Propagation Delay, Data to Output



Waveform 3. 3-State Output Enable Time to High Level and Output Disable Time from High Level



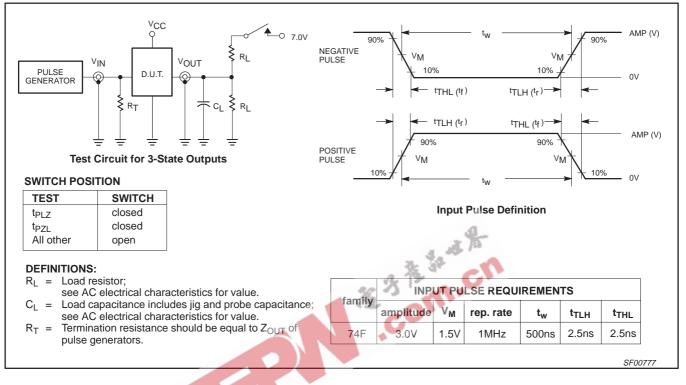
Waveform 2. Propagation Delay, Select to Output

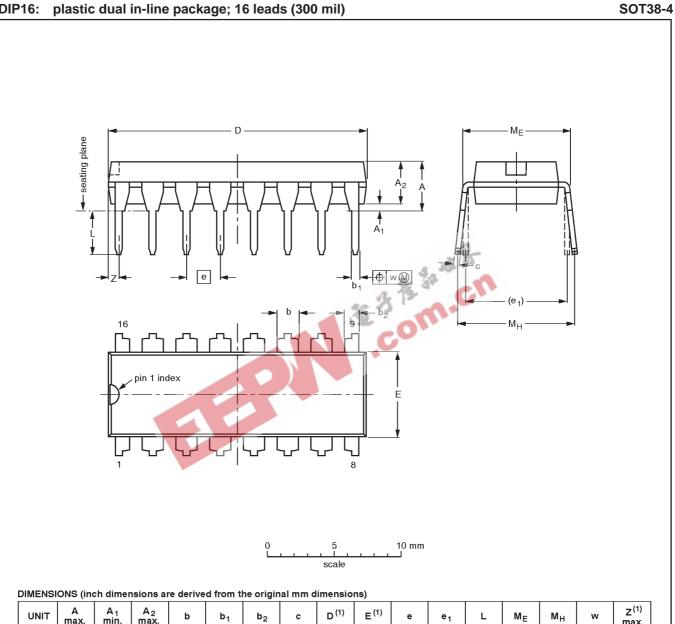


Waveform 4. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

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TEST CIRCUIT AND WAVEFORMS





DIP16: plastic dual in-line package; 16 leads (300 mil)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	с	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

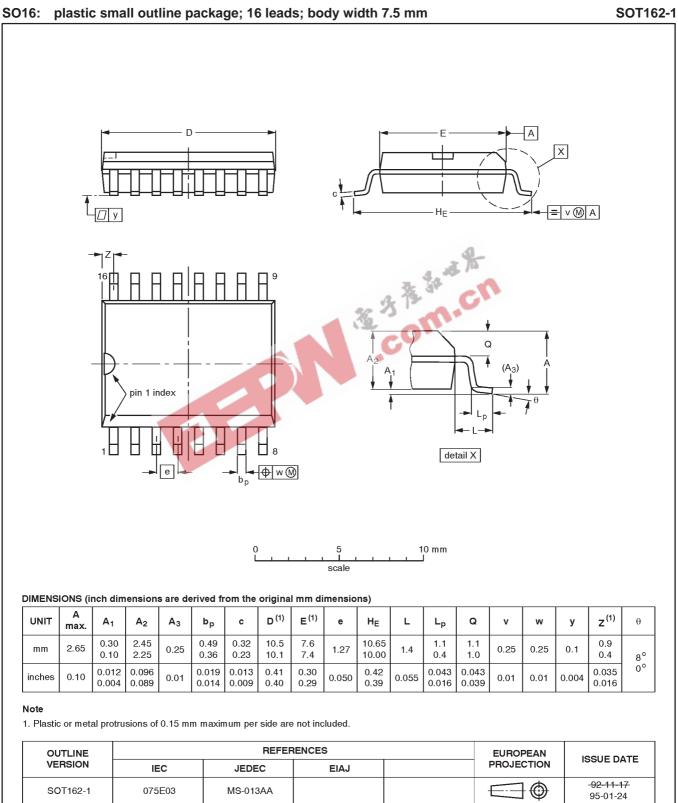
OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT38-4					-92-11-17 95-01-14

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Product specification

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Dual 4-input multiplexer (3-State)



Product specification

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NOTES



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Data sheet status

Data sheet status	Product status	Definition ^[1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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